W, H, McL & N Docket No.

Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, po	est office address and citizenship are as stated	bclow next to my na	ame.		
I believe I am the names are listed I (Insert Title)	e original, first and sole inventor (if only one below) of the subject matter which is claime Seniconductor Device and Fab	d and for which a nate	est is complet on the impaction and the	ator (if plural ed	
the specification	of which is attached hereto unless the follow	ing is checked:		• .	
	was filed on as United States Application Number				
	Application Number	as United States Application Number or PCT Internation berand was amended on			
	(if applicable).			_ \	
I hereby state that by any amendmen	t I have reviewed and understand the content nt referred to above.	s of the above-identif	led specification, including the claim	m(s), as amended	
I acknowledge the	e duty to disclose information which is materi	al to patentability as d	efined in Title 37, Code of Federal R	tegulations, § 1.56.	
	reign priority benefits under Title 35, United cate listed below and have also identified below to the application on which priority is claim to the application on which priority is claim.	OW SHY toteldh seelic	t) - (d) of any foreign application(s) ation for patent or inventor's certifi	for patent or cate having a fil-	
List prior	10-149456(P)	Japan	29/May/1998	Priority Claimed Yes D No	
foreign Eapplications.	(Number) 10-308754 (P)	(Country) Japan	(Day/Month/Year Filed) 29/October/1998	_ 2 Yes \square No	
See note A	(Number)	(Country)	(Day/Month/Year Filed)		
this page)	(Number)	(Country)	(Day/Month/Year Filed)	_ O Yes O No	
	(Number)	(Country)	(Day/Month/Year Filed)	_ O Yes O No	
See note B on bath hereby claim the	ck of this page)		or foreign applications d States provisional application(s) l	isted below.	
	(Application Number)		(Filing Date)		
	(Application Number)	_	(Filing Date)	-	
he first paragraph ty as defined in T und the national or	benefit under Title 35, United States Code, each of the claims of this application is not do of Title 35, United States Code, § 112, I act title 37, Code of Federal Regulations, § 1.56 or PCT international filing date of the applications.	isclosed in the prior to knowledge the duty to which became availablion:	Inited States application in the man disclose information which is mate ole between the filing date of the pr	ner provided by erial to patentabil- ior application	
(List Prior U.S. Applications)	(Application Serial Number)	(Filing Date)	(Status) (patented, pendin	(Status) (patented, pending, abandoned)	
· ,	(Application Serial Number)	(Filing Date)	(Status) (patented, pendin	g, abandoned)	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trad mark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be tru; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of eighth inventor (given name, family name)		
inventor's Signature	Date	•
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